



ISOCOM
COMPONENTS

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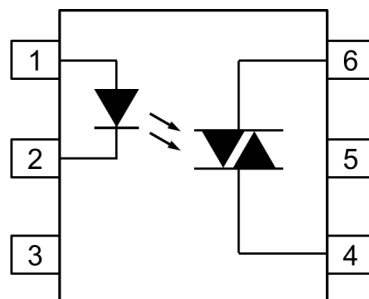
IS6005 / IS6010 / IS6015

DESCRIPTION

The IS6005, IS6010 and IS6015 are optically coupled isolators consisting of a Gallium Arsenide infrared emitting diode coupled with a light activated silicon bilateral switch performing the functions of a triac.

These photocouplers provide random phase control of high current triacs or thyristors. They feature greatly enhanced static dv/dt capability to ensure stable switching performance of inductive loads.

These devices are mounted in a standard 6 pin dual-in-line package.



- 1 Anode
- 2 Cathode
- 3 NC
- 4 Main Terminal
- 5 Substrate
(Do not Connect)
- 6 Main Terminal

FEATURES

- High Repetitive Peak Off-state Voltage
 V_{DRM} : minimum 600V
- High Critical Rate of Rise of Off-state Voltage
 dv/dt : minimum 1000V/ μ s)
- High Isolation Voltage between Input and Output
Viso : 5000Vrms
- Lead Free and RoHS Compliant
- Safety Approvals Pending

APPLICATIONS

- Solenoid / Valve Controls
- Lamp Ballasts
- Static AC Power Switch
- Interfacing Microprocessors to 115 and 240Vac Peripherals
- Solid State Relays
- Incandescent Lamp Dimmers
- Temperature Controls
- Motor Controls

ORDER INFORMATION

- Add G after PN for 10mm lead spacing
- Add SM after PN for Surface Mount
- Add SMT&R after PN for Surface Mount Tape & Reel

ABSOLUTE MAXIMUM RATINGS ($T_A = 25^\circ\text{C}$)

Stresses exceeding the absolute maximum ratings can cause permanent damage to the device. Exposure to absolute maximum ratings for long periods of time can adversely affect reliability.

Input

Forward Current	50mA
Reverse Voltage	6V
Power dissipation	100mW
Junction Temperature	125°C

Output

Off State Output Terminal Voltage	600V
Peak Repetitive Surge Current (Pulse width = 1ms, 120pps)	1A
Power Dissipation	300mW
Junction Temperature	125°C

Total Package

Isolation Voltage	5000V _{RMS}
Total Power Dissipation	330mW
Operating Temperature	-40 to 110°C
Storage Temperature	-55 to 150 °C
Lead Soldering Temperature (10s)	260°C

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IS6005 / IS6010 / IS6015

Recommended Operating Conditions

Parameter	Symbol	Min	Typ	Max	Unit
Supply Voltage	V_{AC}			240	V_{AC}
Forward Current					mA
IS6005	I_F	7.5	10	30	
IS6010		15	20	30	
IS6015		22.5	25	30	
Operating Temperature	T_A	-25		85	$^{\circ}C$

NOTE :

Recommended operating conditions are given as a design guideline to obtain expected performance of the device.

Each item is an independent guideline.

Please also refer to specified characteristics in this document.



IS6005 / IS6010 / IS6015

ELECTRICAL CHARACTERISTICS ($T_A = 25^\circ\text{C}$ unless otherwise specified)

INPUT

Parameter	Symbol	Test Condition	Min	Typ.	Max	Unit
Forward Voltage	V_F	$I_F = 20\text{mA}$		1.2	1.4	V
Reverse Current	I_R	$V_R = 6\text{V}$		0.05	10	μA

OUTPUT

Parameter	Symbol	Test Condition	Min	Typ.	Max	Unit
Peak Off-state Current Either Direction	I_{DRM}	$V_{\text{DRM}} = 600\text{V}$ $I_F = 0\text{mA}$ Note 1			100	nA
On-State Voltage Either Direction	V_{TM}	$I_{\text{TM}} = 100\text{mA}$ (Peak)			3.0	V
Critical Rate of Rise of Off-State Voltage	dv/dt	$I_F = 0\text{mA}$ $V_{\text{IN}} = 240\text{V}_{\text{RMS}}$	1000			V/ μs

COUPLED

Parameter	Symbol	Test Condition	Min	Typ.	Max	Unit
Input Trigger Current Either Direction	I_{FT}	Main Terminal Voltage = 3V Note 2 IS6005 IS6010 IS6015			5 10 15	mA
Holding Current Either Direction	I_{H}			200		μA

ISOLATION

Parameter	Symbol	Test Condition	Min	Typ.	Max	Unit
Insulation Voltage	V_{ISO}	AC 1 minute, RH 40 to 60%	5000			V_{RMS}

Measured with input leads shorted together and output leads shorted together.

Note 1 : Test Voltage must be applied within static dv/dt rating.

Note 2 : Guaranteed to trigger at an I_F value less than or equal to max I_{FT} ,
Recommended I_F lies between Rated I_{FT} to Absolute Max I_F .

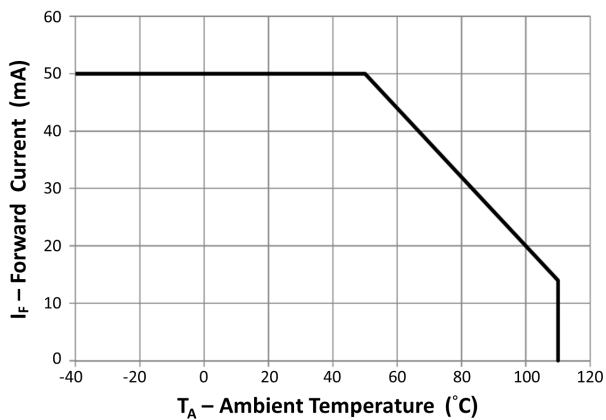


Fig 1 Forward Current vs Ambient Temperature

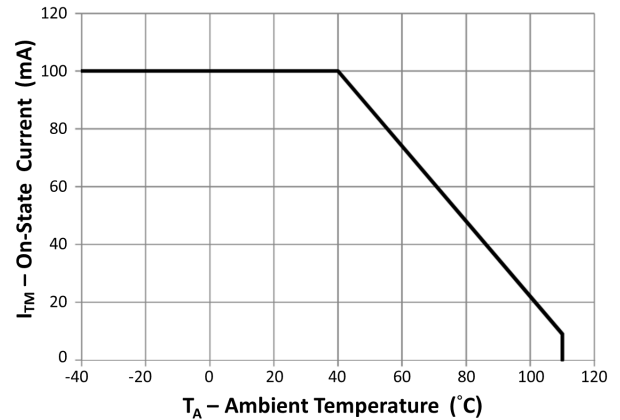


Fig 2 On-State Current vs Ambient Temperature

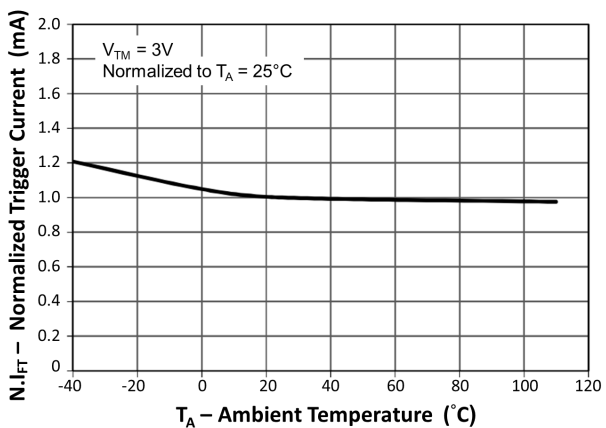


Fig 3 Normalized Trigger Current vs Ambient Temperature

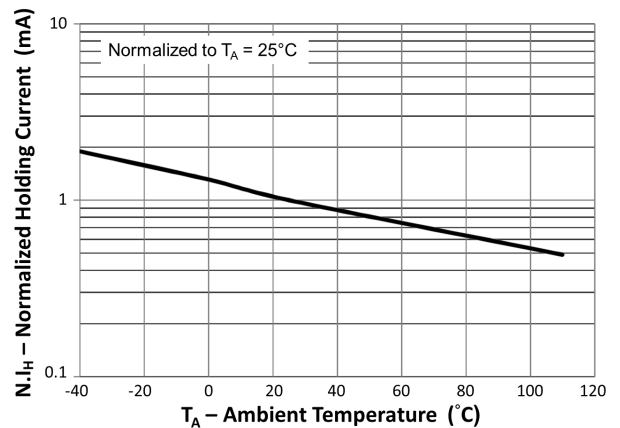


Fig 4 Normalized Holding Current vs Ambient Temperature

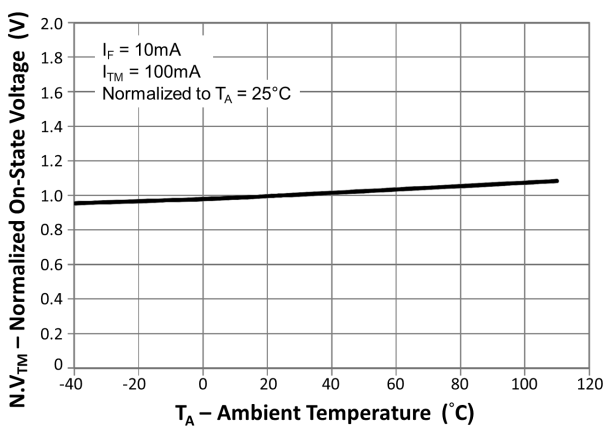


Fig 5 Normalized On-State Voltage vs Ambient Temperature

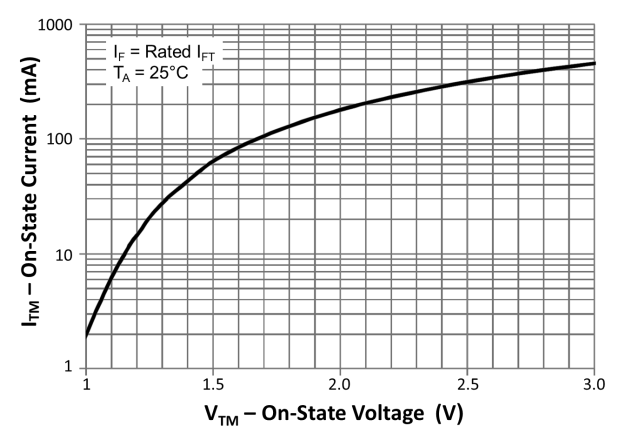


Fig 6 On-State Current vs On-State Voltage

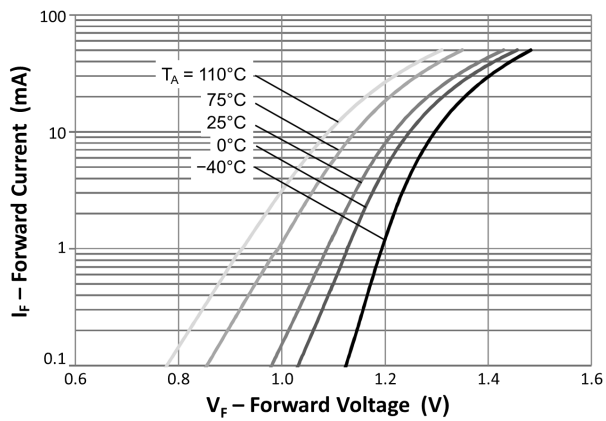


Fig 7 Forward Current vs Forward Voltage

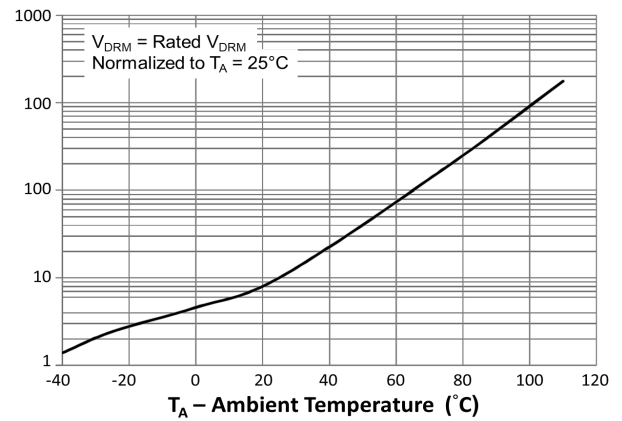


Fig 8 Normalized Peak Off-State Current vs Ambient Temperature



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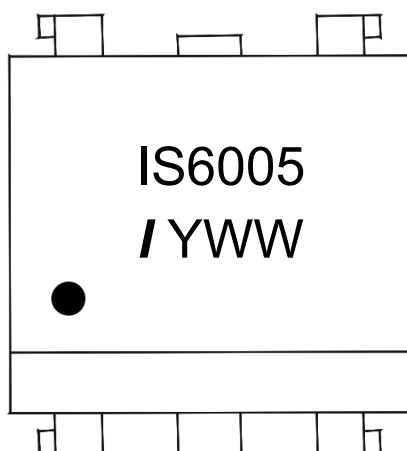
IS6005 / IS6010 / IS6015

ORDER INFORMATION

IS6005 / IS6010 / IS6015			
After PN	PN	Description	Packing quantity
None	IS6005, IS6010, IS6015	Standard DIP6	65 pcs per tube
G	IS6005G, IS6010G, IS6015G	10mm Lead Spacing	65 pcs per tube
SM	IS6005SM, IS6010SM IS6015SM	Surface Mount	65 pcs per tube
SMT&R	IS6005SMT&R, IS6010SMT&R IS6015SMT&R	Surface Mount Tape & Reel	1000 pcs per reel

DEVICE MARKING

Example : IS6005



IS6005	denotes Device Part Number
/	denotes Isocom
Y	denotes 1 digit Year code
WW	denotes 2 digit Week code

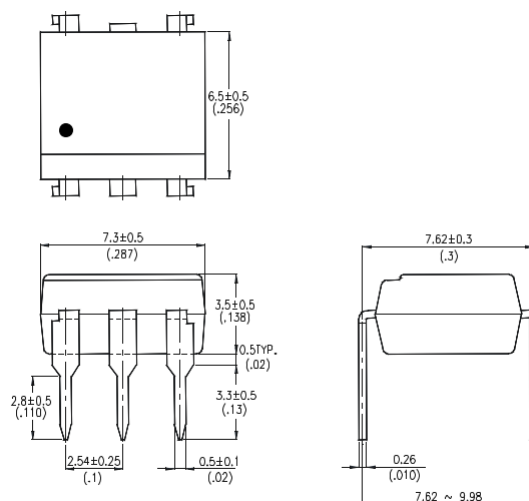


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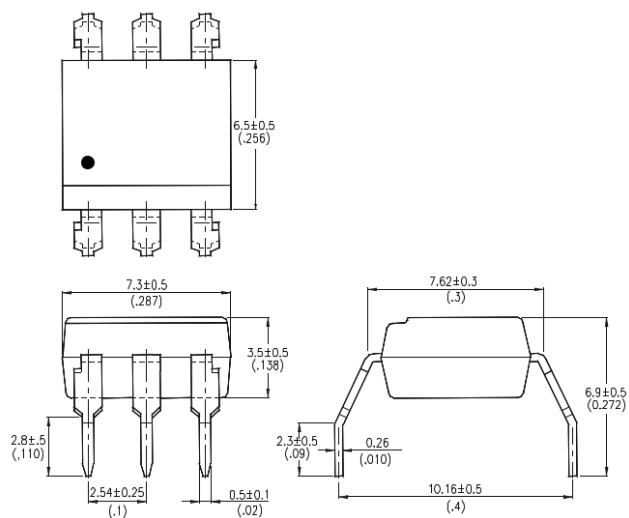
IS6005 / IS6010 / IS6015

PACKAGE DIMENSIONS in mm (inch)

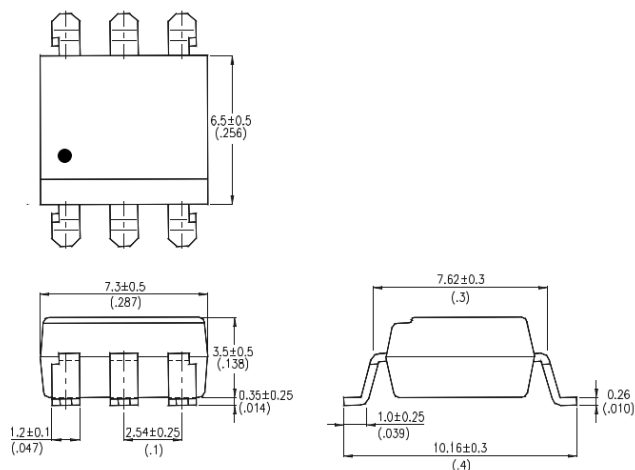
DIP



G Form

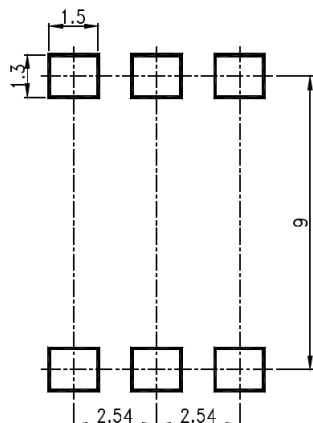


SMD

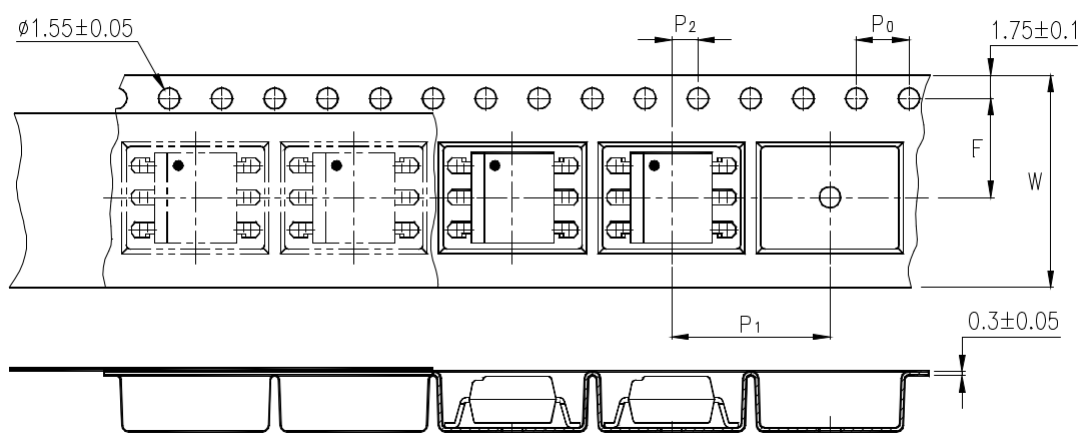




RECOMMENDED PAD LAYOUT FOR SMD (mm)



TAPE AND REEL PACKAGING



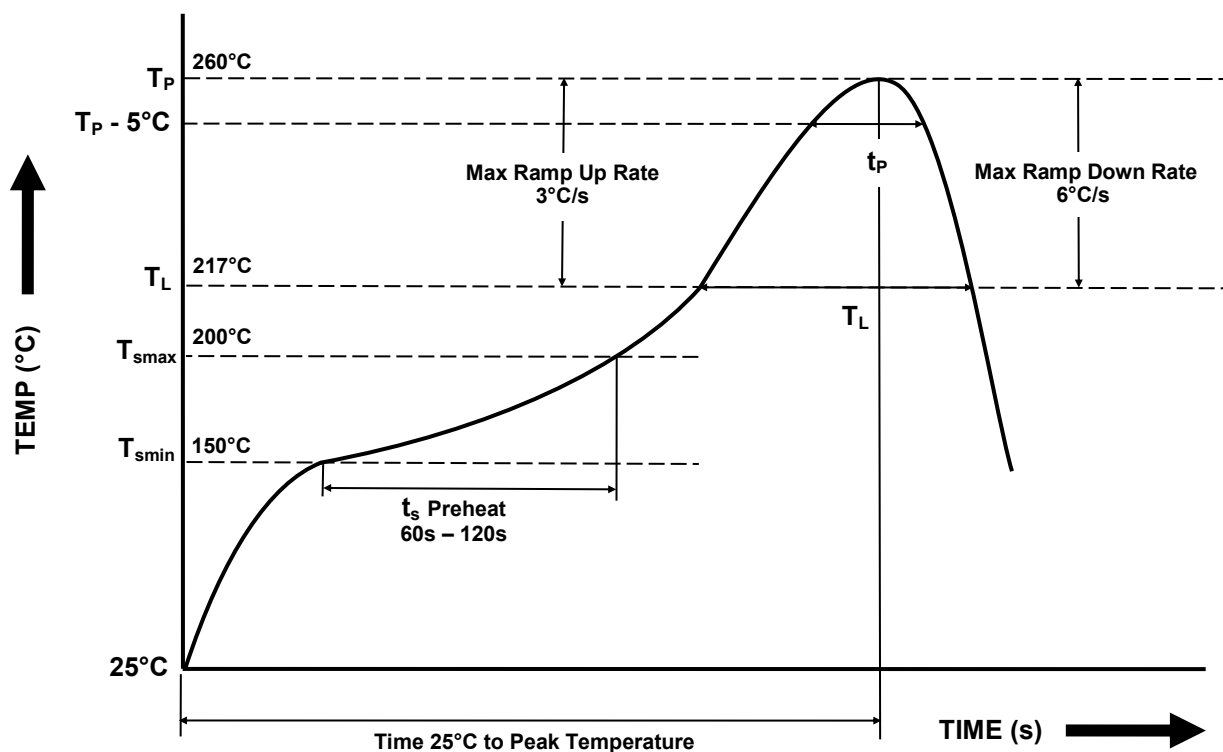
Description	Symbol	Dimension mm (inch)
Tape Width	W	16 ± 0.3 (0.63)
Pitch of Sprocket Holes	P_0	4 ± 0.1 (0.15)
Distance of Compartment to Sprocket Holes	F	7.5 ± 0.1 (0.295)
	P_2	2 ± 0.1 (0.079)
Distance of Compartment to Compartment	P_1	12 ± 0.1 (0.472)



IR REFLOW SOLDERING TEMPERATURE PROFILE

Note : One Time Reflow Soldering is Recommended.

Do Not Immerse Device Body in Solder Paste.



Profile Details	Conditions
Preheat <ul style="list-style-type: none">- Min Temperature (T_{SMIN})- Max Temperature (T_{SMAX})- Time T_{SMIN} to T_{SMAX} (t_s)	150°C 200°C 60s - 120s
Soldering Zone <ul style="list-style-type: none">- Peak Temperature (T_P)- Time at Peak Temperature- Liquidous Temperature (T_L)- Time within 5°C of Actual Peak Temperature ($T_P - 5^\circ\text{C}$)- Time maintained above T_L (t_L)- Ramp Up Rate (T_L to T_P)- Ramp Down Rate (T_P to T_L)	260°C 10s max 217°C 30s max 60s - 100s 3°C/s max 6°C/s max
Average Ramp Up Rate (T_{smax} to T_P)	3°C/s max
Time 25°C to Peak Temperature	8 minutes max

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